



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

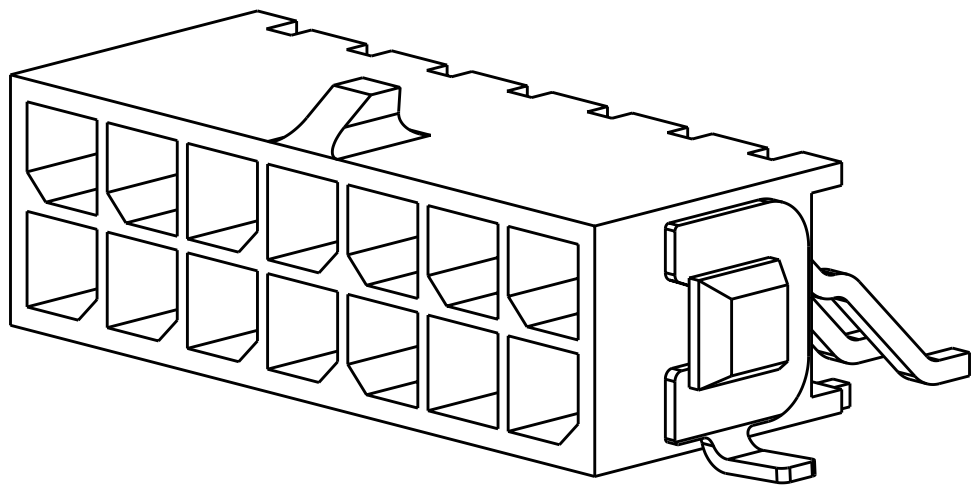
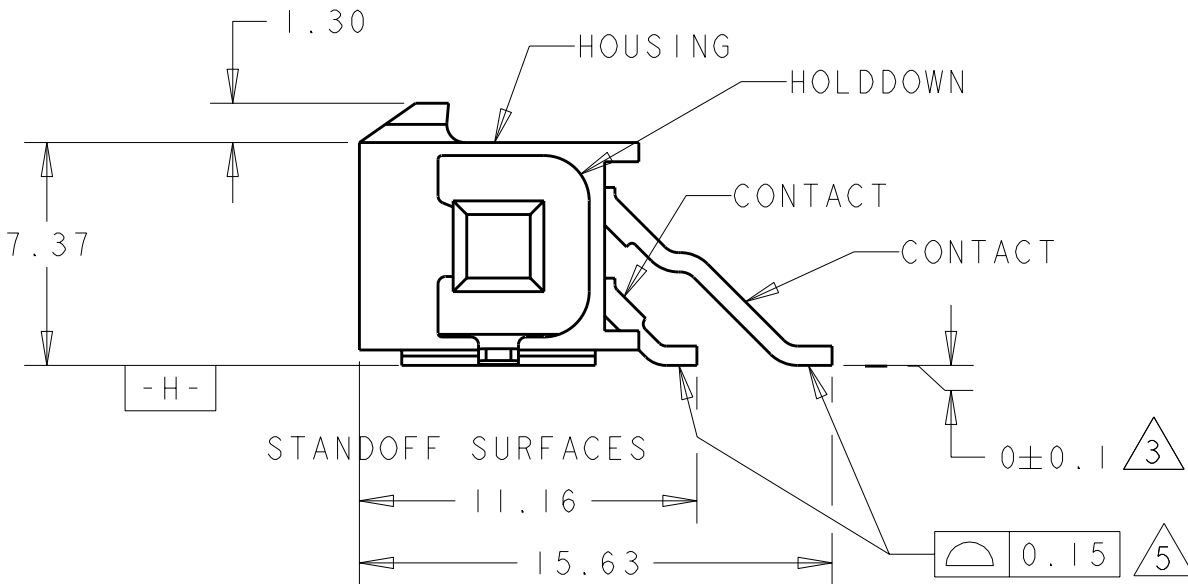
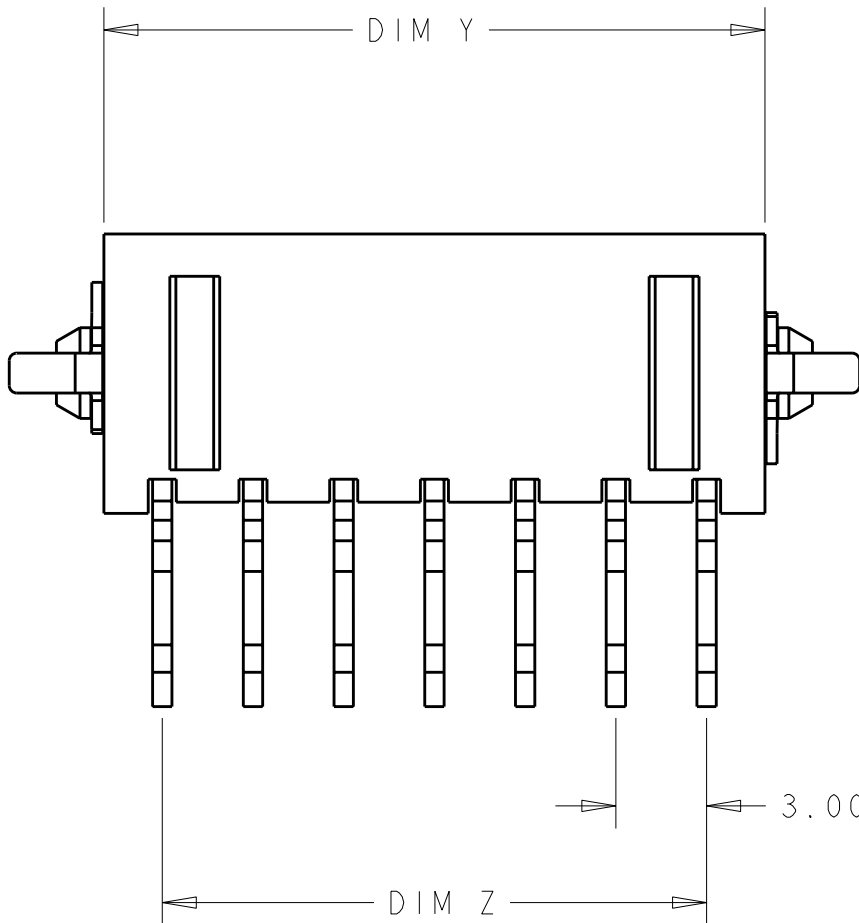
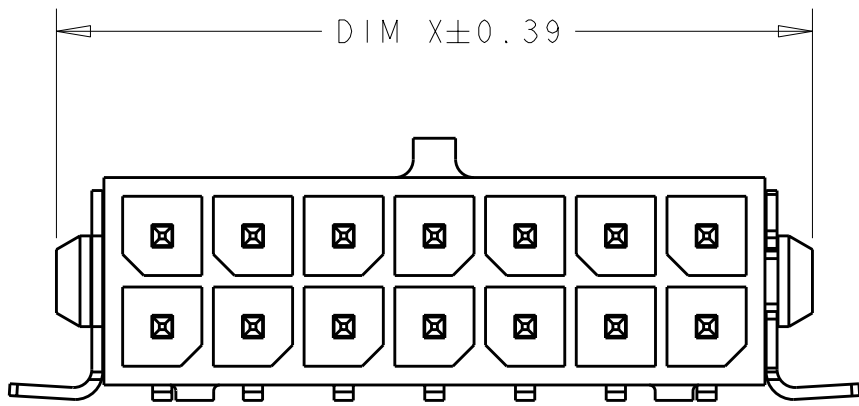
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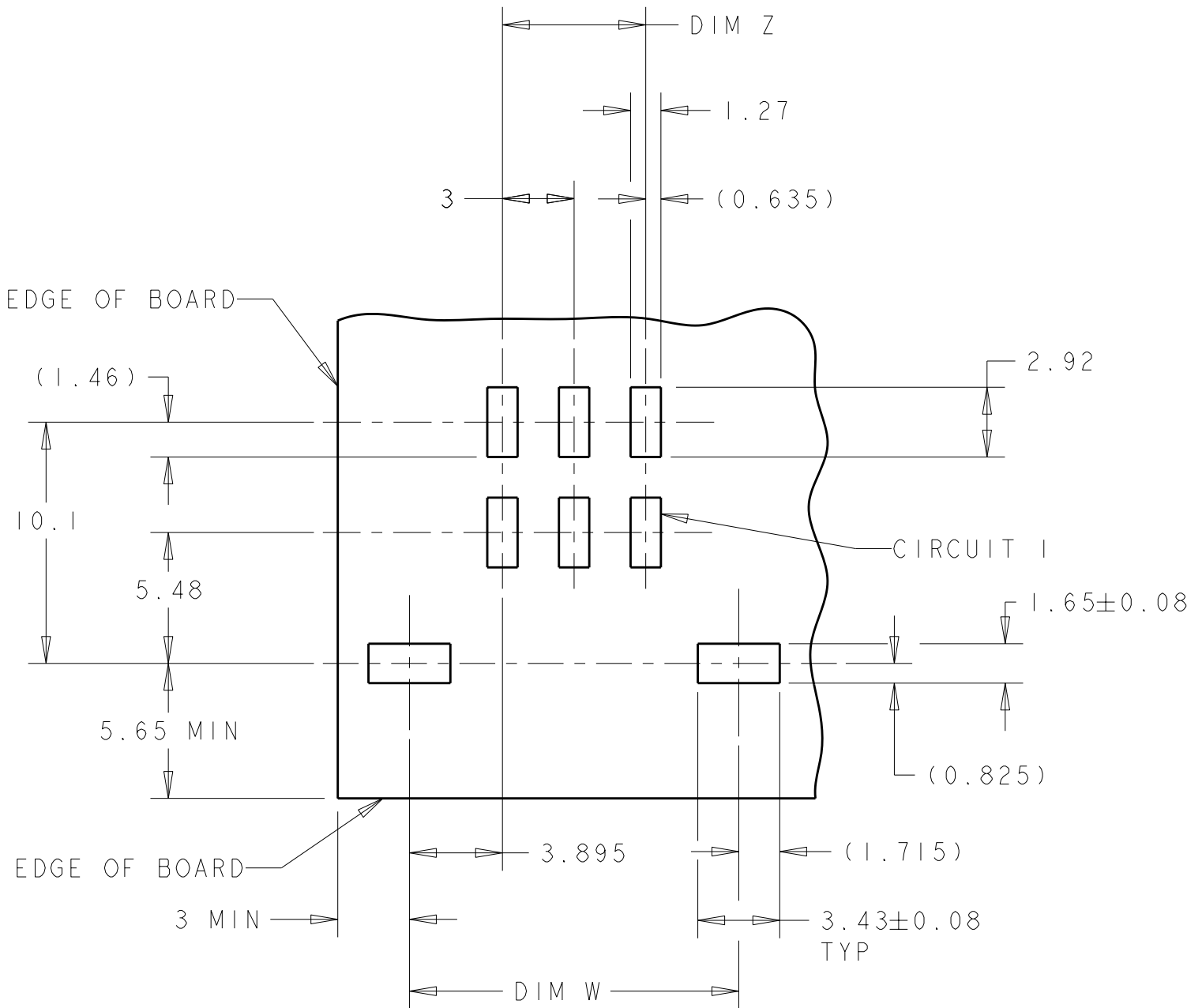


LOC	DIST	REVISIONS					
		P	LTR	DESCRIPTION	DATE	DWN	APVD
CM	00		G1	REVISED PER ECO-11-005027	15MAR2011	RK	HMR

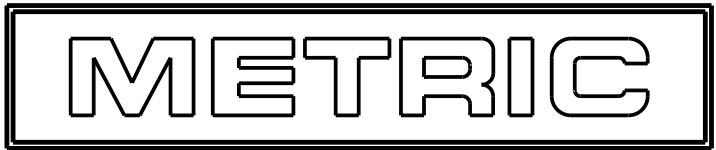


SCALE 5:1




- 1 MATERIAL;  
CONTACTS - BRASS.  
HOUSING - UL 94V-0 RATED HIGH TEMP NYLON,  
COLOR; BLACK.  
HOLDDOWNS - PHOSPHOR BRONZE.
- 2 PLATING;  
CONTACTS - 0.38µm MINIMUM GOLD OVER 2.54µm  
MINIMUM NICKEL ON MATING AREA.  
2.54µm TIN-LEAD MINIMUM OVER 2.54µm  
NICKEL MINIMUM ON SOLDER TAIL.  
HOLDDOWNS - 2.54µm TIN-LEAD.
- 3 DIMENSION APPLIES TO SOLDERTAIL SURFACES  
AND STANDOFF SURFACES.
- 4 RECOMMENDED PC BOARD THICKNESS OF 1.57.
- 5 ALL SOLDERTAILS AND HOLDDOWNS.
- 6 PLATING;  
CONTACTS - 0.38µm MINIMUM GOLD OVER 2.54µm  
MINIMUM NICKEL ON MATING AREA.  
2.54µm MATTE TIN MINIMUM OVER 2.54µm  
NICKEL MINIMUM ON SOLDER TAIL.  
HOLDDOWNS - 2.54µm MATTE TIN.



RECOMMENDED PCB LAYOUT  
(COMPONENT SIDE)



6	36.86	40.79	33.00	40.00	24	5-794628-4
6	33.86	37.79	30.00	37.00	22	5-794628-2
6	30.86	34.79	27.00	34.00	20	5-794628-0
6	27.86	31.79	24.00	31.00	18	4-794628-8
6	24.86	28.79	21.00	28.00	16	4-794628-6
6	21.86	25.79	18.00	25.00	14	4-794628-4
6	18.86	22.79	15.00	22.00	12	4-794628-2
6	15.86	19.79	12.00	19.00	10	4-794628-0
6	12.86	16.79	9.00	16.00	8	3-794628-8
6	9.86	13.79	6.00	13.00	6	3-794628-6
6	6.86	10.79	3.00	10.00	4	3-794628-4
6	3.86	7.79	-	7.00	2	3-794628-2
2	36.86	40.79	33.00	40.00	24	2-794628-4
2	33.86	37.79	30.00	37.00	22	2-794628-2
2	30.86	34.79	27.00	34.00	20	2-794628-0
2	27.86	31.79	24.00	31.00	18	1-794628-8
2	24.86	28.79	21.00	28.00	16	1-794628-6
2	21.86	25.79	18.00	25.00	14	1-794628-4
2	18.86	22.79	15.00	22.00	12	1-794628-2
2	15.86	19.79	12.00	19.00	10	1-794628-0
2	12.86	16.79	9.00	16.00	8	794628-8
2	9.86	13.79	6.00	13.00	6	794628-6
2	6.86	10.79	3.00	10.00	4	794628-4
2	3.86	7.79	-	7.00	2	794628-2
FINISH	DIM Y	DIM W	DIM Z	DIM X	NO. OF POSN.	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.			DWN K. WHITAKER 19MAR2003		 TE Connectivity	
			CHK C. JONES 19MAR2003			
DIMENSIONS: mm			TOLERANCES UNLESS OTHERWISE SPECIFIED:		NAME	
			APVD C. JONES 19MAR2003		SURFACE MOUNT, RIGHT ANGLE, SURFACE MOUNT HOLDDOWN, ASSEMBLY, 15 GOLD HEADER, DUAL ROW, MICRO MATE-N-LOK™	
			PRODUCT SPEC			
			APPLICATION SPEC			
			WEIGHT			
MATERIAL 			0 PLC ±. 1 PLC ±. 2 PLC ±0.13 3 PLC ±. 4 PLC ±. ANGLES ±. FINISH		SIZE	
			SEE TABLE		CAGE CODE	
			CUSTOMER DRAWING		DRAWING NO	
					RESTRICTED TO	
					A200779 C-794628	
					SCALE	
					4:1	
					SHEET	
					1 OF	
					REV	
					G1	